

# 1MHz, 18V, 3.0A Synchronous Step-Down Converter

In SOT563

## FEATURES

- High Efficiency: Up to 93%(@3.3V)
- 1MHz Frequency Operation
- Up to 3.0A Output Current@1.2V<sub>OUT</sub>
- Low R<sub>DS(ON)</sub> for internal switches:  
70mΩ/35mΩ(top/bottom)
- 4.5V to 18V Input Voltage Range
- 0.805V Reference
- Current mode COT control to achieve fast transient responses
- Integrated internal compensation
- Stable with Low ESR Ceramic Output Capacitors
- Over Current Protection with Hiccup Mode
- Thermal Shutdown
- Inrush Current Limit and Soft Start
- Available in SOT563 Package

## GENERAL DESCRIPTION

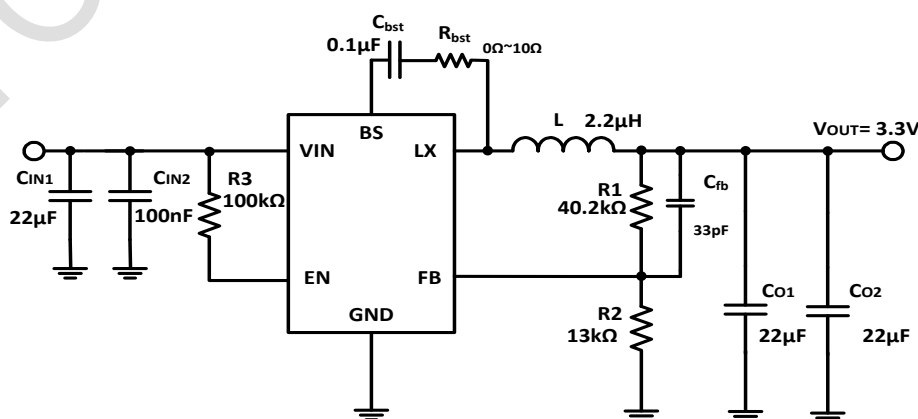
The STI3453 is a high efficiency 1MHz current mode constant on-time (CM-COT) control mode synchronous step-down DC-DC converter capable of delivering 3A current. STI3453 integrates main switch and synchronous switch with very low R<sub>DS(ON)</sub> to minimize the conduction loss. Low output voltage ripple and small external inductor and capacitor size are achieved with 1MHz switching frequency. It adopts the CM-COT architecture to achieve fast transient responses for high voltage step down applications.

The STI3453 requires a minimum number of readily available standard external components and is available in a space saving 6-pin SOT563 ROHS compliant package.

## APPLICATIONS

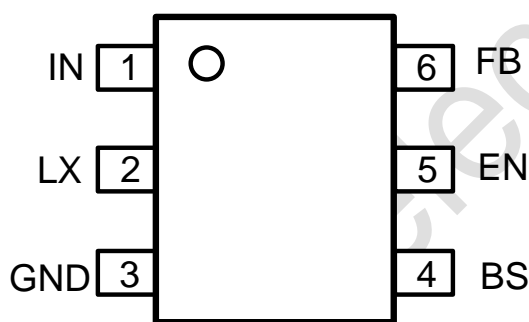
- Digital Set Top Boxes
- Flat Panel Television and Monitors
- Notebook computer
- Wireless and DSL Modems

## TYPICAL APPLICATION



**ABSOLUTE MAXIMUM RATINGS** (Note 1)

Parameter	Min	Max	Unit
Input Supply Voltage, EN	-0.3	20	V
LX Voltages	-0.3	20	V
LX Voltages (<10ns transient)	-4.5	22	V
FB Voltage	-0.3	6	V
BS Voltage	-0.3	23	V
Storage Temperature Range	-65	150	°C
Junction Temperature (Note 2)	160		°C
Power Dissipation	1000		mW
Lead Temperature (Soldering, 10s)	260		°C

**PACKAGE/ORDER INFORMATION**

**SOT563**
**Top Mark: SC3XXX (SC3: Device Code, XXX: Inside Code)**

Part Number	Package	Top Mark	Quantity/ Reel
STI3453	SOT563	SC3XXX	5000

STI3453 devices are Pb-free and RoHS compliant.

## PIN FUNCTIONS

Pin	Name	Function
1	IN	Power Supply Pin
2	LX	Switching Pin
3	GND	Ground
4	BS	Bootstrap. A capacitor connected between LX and BS pins is required to form a floating supply across the high-side switch driver.
5	EN	Drive this pin to a logic-high to enable the IC. Drive to a logic-low to disable the IC and enter micro-power shutdown mode. Do not leave EN pin floating.
6	FB	Output Voltage feedback input. Connect FB to the center point of the external resistor divider.

## ESD RATING

Items	Description	Value	Unit
$V_{ESD\_HBM}$	Human Body Model for all pins	$\pm 2000$	V
$V_{ESD\_CDM}$	Charged Device Model for all pins	$\pm 2000$	V

JEDEC specification JS-001

## RECOMMENDED OPERATING CONDITIONS

Items	Description	Min	Max	Unit
Voltage Range	IN	4.5	18	V
$T_J$	Operating Temperature Range	-40	125	°C

## THERMAL RESISTANCE<sub>(Note3)</sub>

Items	Description	Value	Unit
$\theta_{JA}$	Junction-to-ambient thermal resistance	130	°C/W
$\theta_{JC}$	Junction-to-case(top) thermal resistance	60	°C/W

## ELECTRICAL CHARACTERISTICS

$V_{IN}=12V$ ,  $V_{OUT}=3.3V$ ,  $T_A = 25^{\circ}C$ , unless otherwise noted.

Parameter	Conditions	Min	Typ	Max	Unit
Input Voltage Range		4.5		18	V
OVP Threshold		18.7	19.3	19.8	V
UVLO Rising Threshold		4.0	4.2	4.35	V
UVLO Hysteresis		0.4	0.45	0.5	V
Quiescent Current	$V_{EN}=2.0V$ , $I_{OUT}=0A$ , $V_{FB}=V_{REF} \times 105\%$		300		$\mu A$
Shutdown Current	$V_{IN}=12V$ , $EN=0V$		5	10	$\mu A$
Regulated Feedback Voltage	$T_A=25^{\circ}C$ , $V_{IN}=12V$	0.793	0.805	0.817	V
High-Side Switch On-Resistance			70	110	m $\Omega$
Low-Side Switch On-Resistance			35	50	m $\Omega$
High-Side Switch Leakage Current	$V_{EN}=0V$ , $V_{LX}=0V$	1		10	$\mu A$
Switch Valley Current Limit	Minimum Duty Cycle	3.7	4	4.5	A
On Time	$V_{IN}=12V$ , $V_{OUT}=1.2V$ , $I_{OUT}=1A$	80	110	160	ns
Oscillation Frequency		900	1000	1100	kHz
Maximum Duty Cycle			65		%
Minimum On-Time (Note 4)		70	80	100	ns
Soft Start Time		0.7	1	1.3	ms
Hiccup on Time (Note 4)			1.2		ms
Hiccup Time Before Restart			3.6		ms
EN Rising Threshold		0.8	0.95	1.05	V
EN Hysteresis			80		mV
Thermal Shutdown Threshold (Note 4)			165		$^{\circ}C$
Thermal Shutdown Hysteresis (Note 4)			30		$^{\circ}C$

**Note 1:** Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

**Note 2:**  $T_J$  is calculated from the ambient temperature  $T_A$  and power dissipation  $P_D$  according to the following formula:  $T_J = T_A + P_D \times \theta_{JA}$ . The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$ .

**Note 3:** Measured on JESD51-7, 4-layer PCB.

**Note 4:** Guaranteed by design.

## BLOCK DIAGRAM

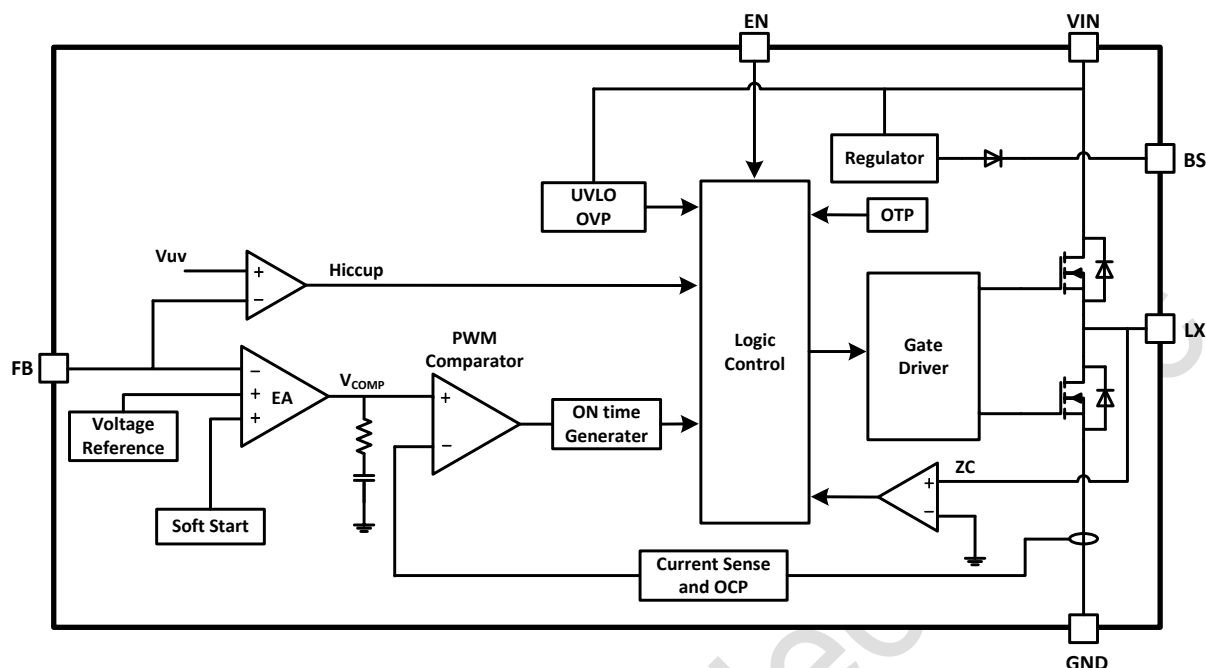


Figure 1. STI3453 Block Diagram

## OPERATION DESCRIPTION

### Internal Regulator

The STI3453 is a current mode constant on-time (CM-COT) step down DC/DC converter that provides excellent transient response with no extra external compensation components. This device contains low resistance, high voltage high side and low side power MOSFETs, and operates at 1MHz operating frequency to ensure a compact, high efficiency design with excellent AC and DC performance.

### Error Amplifier

STI3453 adopts operational transconductance amplifier (OTA) as error amplifier. The error amplifier compares the FB pin voltage with the internal FB reference ( $V_{REF}$ ) and outputs a current proportional to the difference between the two. This output current is then used to charge or discharge the internal compensation network to form the  $V_{COMP}$  voltage, which is used to compare with the low side power MOSFET current sensing signal and trigger on time pulse. The optimized internal compensation network minimizes the external component counts and simplifies the control loop design.

### Internal Soft-Start

The soft-start is implemented to prevent the converter output voltage from overshooting during startup. When the chip starts, the internal circuitry generates a soft-start voltage (SS) ramping up from 0V to  $V_{REF}$ . When it is lower than the internal FB reference ( $V_{REF}$ ), SS overrides REF so the error amplifier uses SS as the reference. When SS is higher than  $V_{REF}$ ,  $V_{REF}$  regains control. The SS time is internally fixed to 1ms typically.

### Over-Current-Protection and Short Circuits Protection

The STI3453 has cycle-by-cycle valley current limit function. When the inductor current valley value is larger than the valley current limit during low side MOSFET on state, the device enters into valley over current protection mode and low side MOSFET keeps on state until inductor current drops down to the value equal or lower than the valley current limit, and then on time pulse could be generated and high side MOSFET could turn on again.

If the output is short to GND and the output voltage drop until feedback voltage  $V_{FB}$  is below the output under-voltage  $V_{UV}$  threshold which is typically 45% of  $V_{REF}$ , STI3453 enters into hiccup mode to periodically disable and restart switching operation. The hiccup mode helps to reduce power dissipation and thermal rise during output short condition. The period of STI3453 hiccup mode is typically 4.8ms.

### Startup and Shutdown

If both VIN and EN are higher than their appropriate thresholds, the chip starts switching operation. The reference block starts first, generating stable reference voltage and currents, and then the internal regulator is enabled. The regulator provides stable supply for the remaining circuitries. Three events can shut down the chip: EN low, VIN low and thermal shutdown. In the shutdown procedure, the signaling path is first blocked to avoid any fault triggering. The  $V_{COMP}$  voltage and the internal supply rail are then pulled down. The floating driver is not subject to this shutdown command.

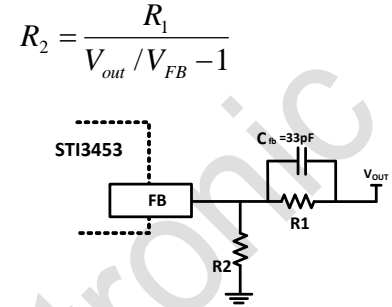
## APPLICATION INFORMATION

### Setting the Output Voltage

The external resistor divider is used to set the output voltage (see Typical Application on page 1). Choose R1 to be around 40.2kΩ for optimal transient response. R2 is then given by:

**Table 1: Selection for Common Output Voltages**

V <sub>OUT</sub> (V)	R1 (kΩ)	R2 (kΩ)	C <sub>FB</sub> (pF)	L (μH)
5	40.2	7.68	33	2.2
3.3	40.2	13	33	2.2
2.5	40.2	19.1	33	2.2
1.8	40.2	32.4	33	1.5
1.5	40.2	45.3	33	1.5
1.2	40.2	82	33	1.0
1	20.5	84.5	33	1.0



**Figure 2. Feedback Network**

A C<sub>fb</sub> capacitor paralleling with high side divider resistor R1 can be used to improve load transient performance. It adds a zero in the frequency  $1/2\pi \cdot R1 \cdot C_{fb}$  to increase bandwidth of the system. 33pF C<sub>fb</sub> is sufficient in most application and increasing C<sub>fb</sub> capacitance can reduce output ripple value in fast transient load current condition.

### Selecting the Inductor

A DC current rating of at least 25% percent higher than the maximum load current is recommended for most applications. Inductance value is related to inductor ripple current value, input voltage, output voltage setting and switching frequency. The inductor value can be derived from the following equation:

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_L \times f_{OSC}}$$

Where  $\Delta I_L$  is inductor ripple current. Large value inductors result in lower ripple current and small value inductors result in high ripple current, so inductor value has effect on output voltage ripple value. DC resistance of inductor which has impact on efficiency of DC/DC converter should be taken into account when selecting the inductor. The maximum inductor peak current is:

$$I_{L(MAX)} = I_{LOAD} + \frac{\Delta I_L}{2}$$

Under light load conditions, larger inductance is recommended for improved light load efficiency.

### Selecting the Output Capacitor

The output capacitor (Co1 and Co2) is required to maintain the DC output voltage. Ceramic, tantalum, or low ESR electrolytic capacitors are recommended. Low ESR capacitors are preferred to keep the output voltage ripple low. The output voltage ripple can be estimated by:

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_s \times L} \times \left[ 1 - \frac{V_{OUT}}{V_{IN}} \right] \times \left[ R_{ESR} + \frac{1}{8 \times f_s \times C_2} \right]$$

Where  $L$  is the inductor value and  $R_{ESR}$  is the equivalent series resistance (ESR) value of the output capacitor. In the case of ceramic capacitors, the impedance at the switching frequency is dominated by the capacitance. The output voltage ripple is mainly caused by the capacitance. For simplification, the output voltage ripple can be estimated by:

$$\Delta V_{OUT} = \frac{V_{OUT}}{8 \times f_s^2 \times L \times C_2} \times \left[ 1 - \frac{V_{OUT}}{V_{IN}} \right]$$

In the case of tantalum or electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, the output ripple can be approximated to:

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_s \times L} \times \left[ 1 - \frac{V_{OUT}}{V_{IN}} \right] \times R_{ESR}$$

The characteristics of the output capacitor also affect the stability of the regulation system. The STI3453 can be optimized for a wide range of capacitance and ESR values.

### PCB Layout Guide

PCB layout is very important to achieve stable operation. It is highly recommended to duplicate EVB layout for optimum performance. If change is necessary, please follow these guidelines and take Figure 3 for reference.

- 1) Keep the path of switching current short and minimize the loop area formed by Input capacitor, IN pin and GND.
- 2) Bypass ceramic capacitors are suggested to be put close to the IN Pin.
- 3) Ensure all feedback connections are short and direct. Place the feedback resistors as close to the chip as possible.
- 4) VOUT, LX away from sensitive analog areas such as FB.
- 5) Connect IN, LX, and especially GND respectively to a large copper area to cool the chip to improve thermal performance and long-term reliability.

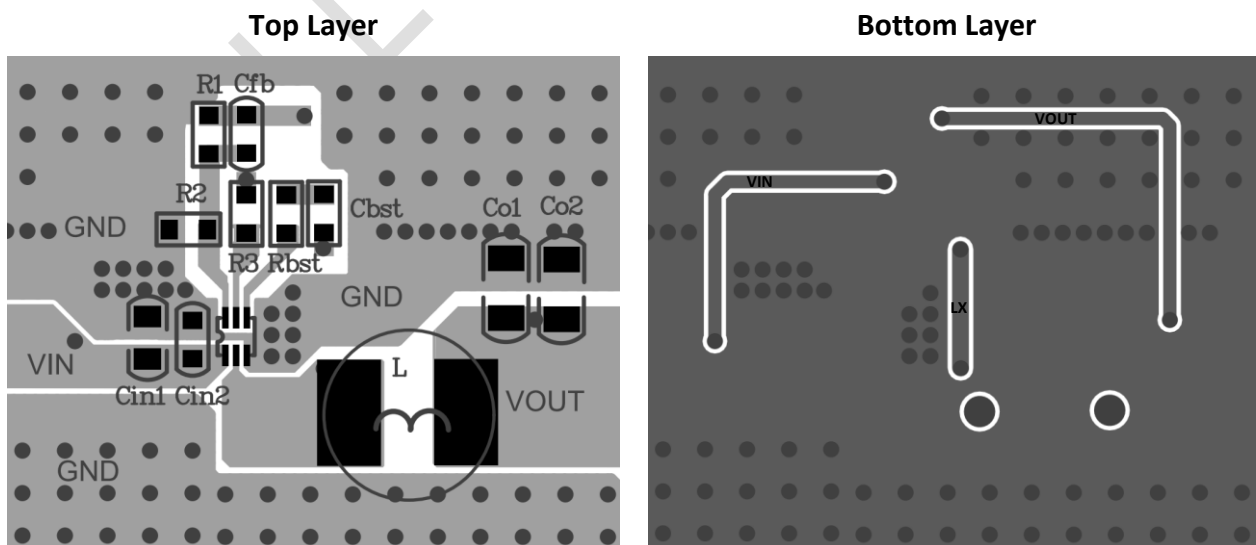


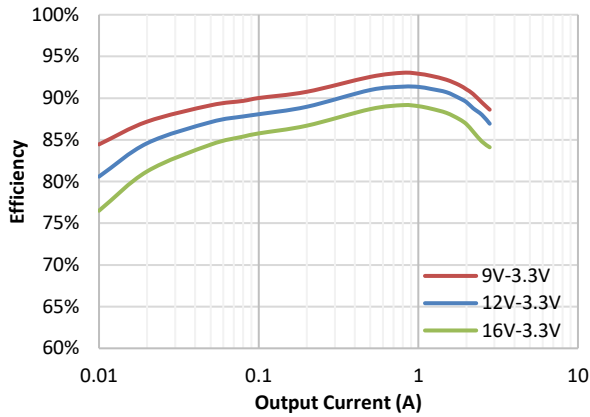
Figure 3. Sample of PCB Layout



## TYPICAL PERFORMANCE CHARACTERISTICS

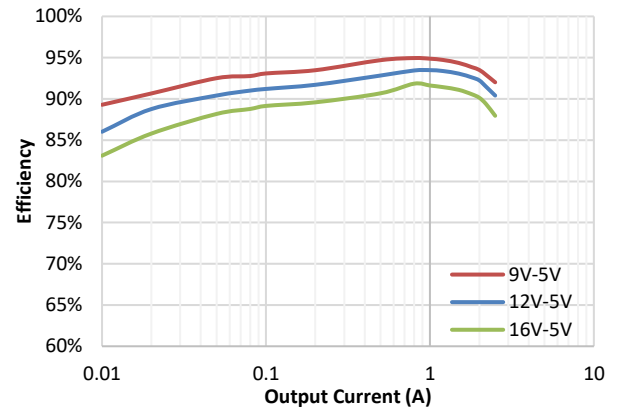
**Efficiency at  $V_{OUT} = 3.3V$**

$V_{OUT} = 3.3V$ ,  $L = 2.2\mu H$ ,  $DCR = 20m\Omega$



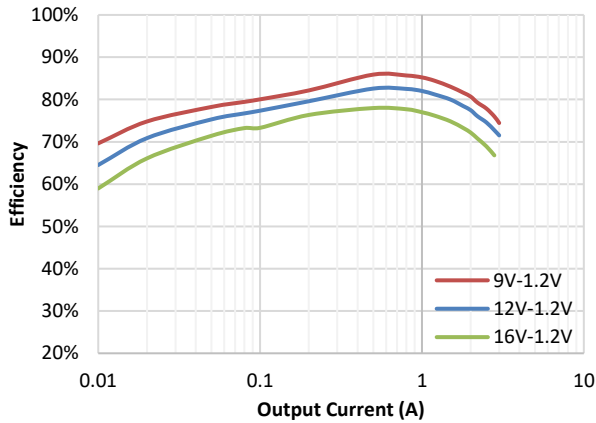
**Efficiency at  $V_{OUT} = 5V$**

$V_{OUT} = 5V$ ,  $L = 2.2\mu H$ ,  $DCR = 20m\Omega$



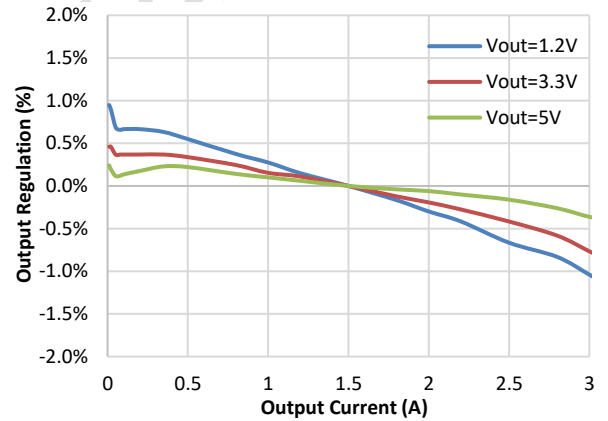
**Efficiency at  $V_{OUT} = 1.2V$**

$V_{OUT} = 1.2V$ ,  $L = 1.0\mu H$ ,  $DCR = 20m\Omega$



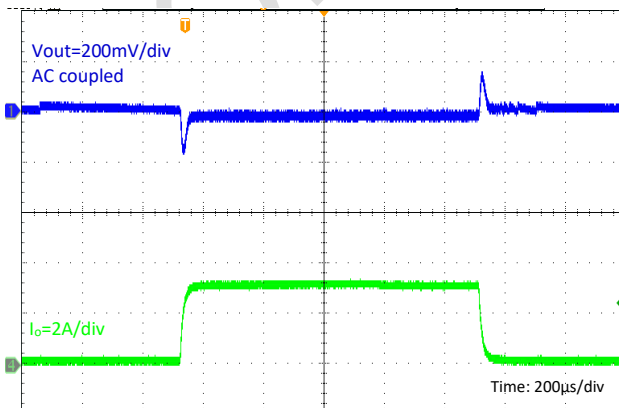
**Load Regulation at  $V_{IN} = 12V$**

$V_{IN} = 12V$ ,  $T_A = 25^\circ C$



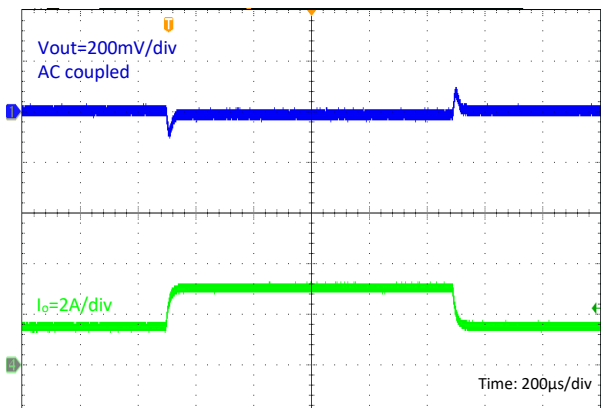
**Load Transient**

$V_{IN} = 12V$ ,  $V_{OUT} = 3.3V$ ,  $I_o = 0A$  to  $3A$



**Load Transient**

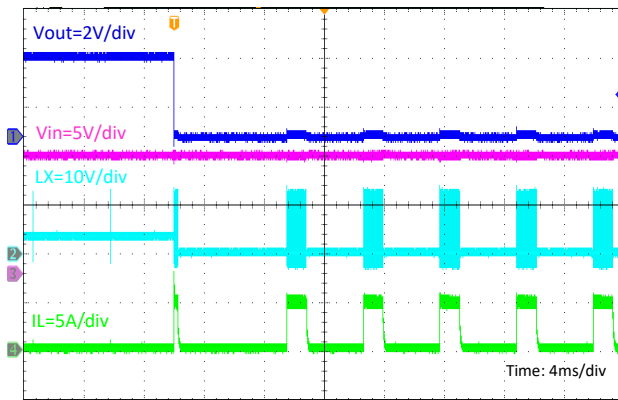
$V_{IN} = 12V$ ,  $V_{OUT} = 3.3V$ ,  $I_o = 1.5A$  to  $3A$



## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

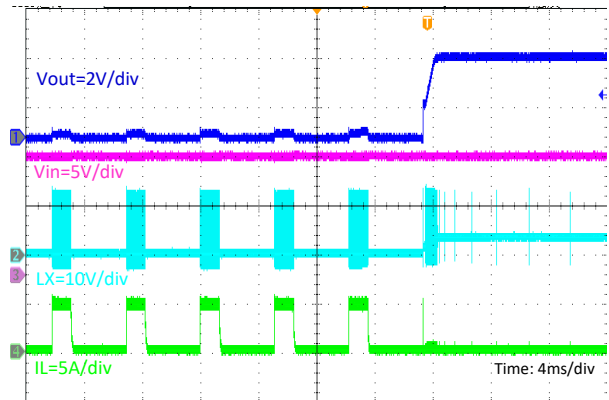
### Output Short Entry

$V_{IN}=12V$ ,  $V_{OUT}=3.3V$ , No Load



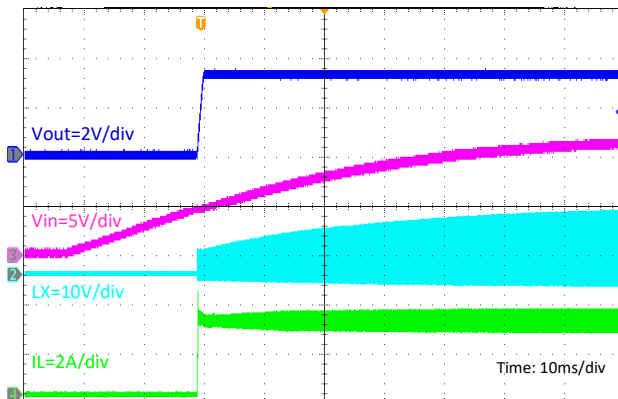
### Output Short Recovery

$V_{IN}=12V$ ,  $V_{OUT}=3.3V$ , No Load



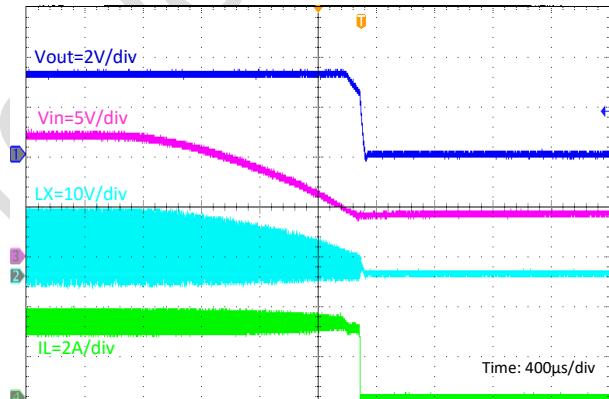
### Input Power On

$V_{IN}=12V$ ,  $V_{OUT}=3.3V$ ,  $I_o=3A$



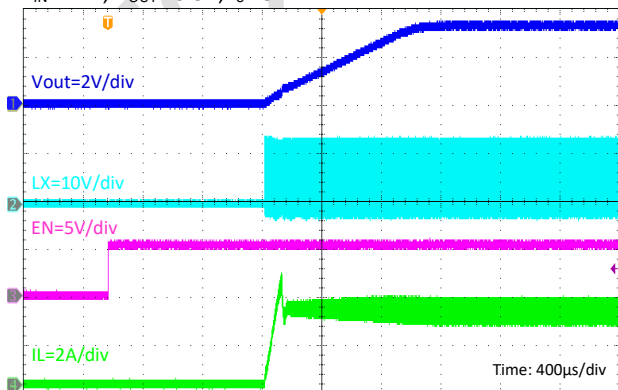
### Input Power Down

$V_{IN}=12V$ ,  $V_{OUT}=3.3V$ ,  $I_o=3A$



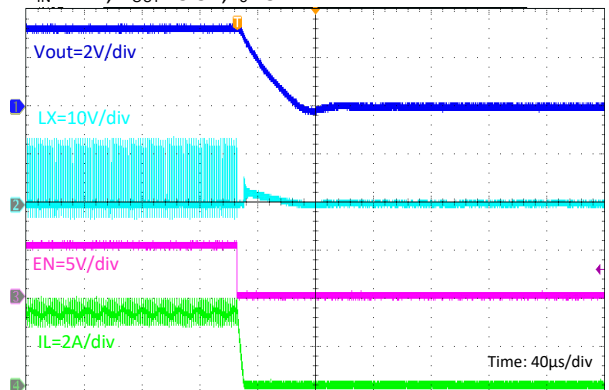
### EN Enable Power On

$V_{IN}=12V$ ,  $V_{OUT}=3.3V$ ,  $I_o=3A$



### EN Disable Power down

$V_{IN}=12V$ ,  $V_{OUT}=3.3V$ ,  $I_o=3A$



## TYPICAL APPLICATION CIRCUITS

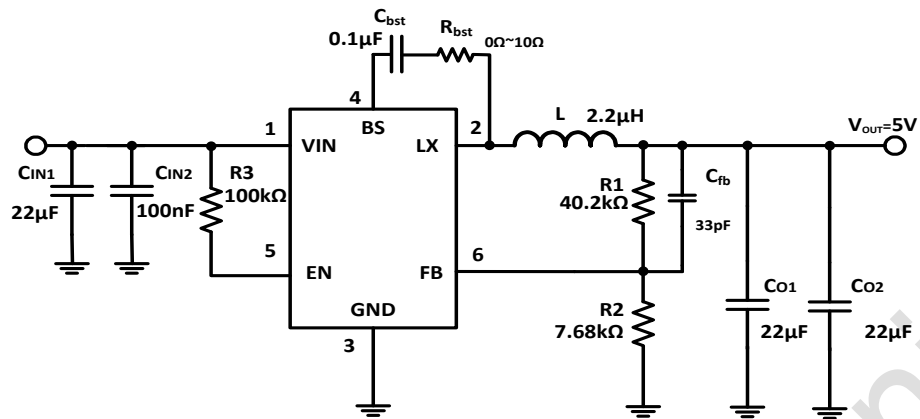


Figure 4. 12V<sub>IN</sub>, 5V Output

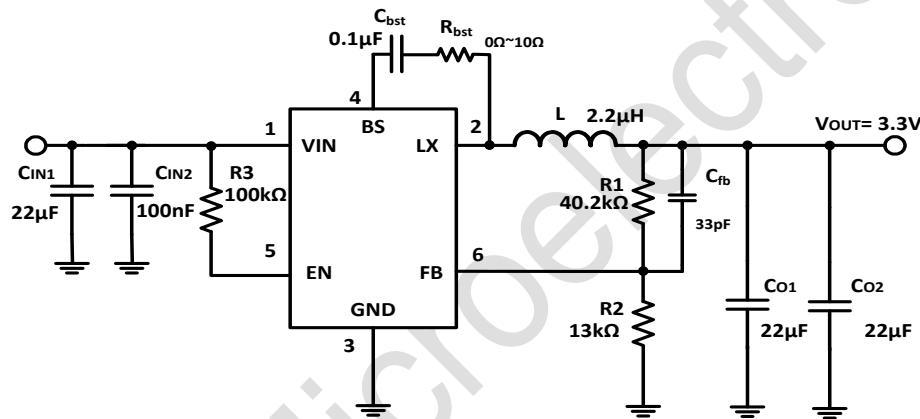


Figure 5. 12V<sub>IN</sub>, 3.3V Output

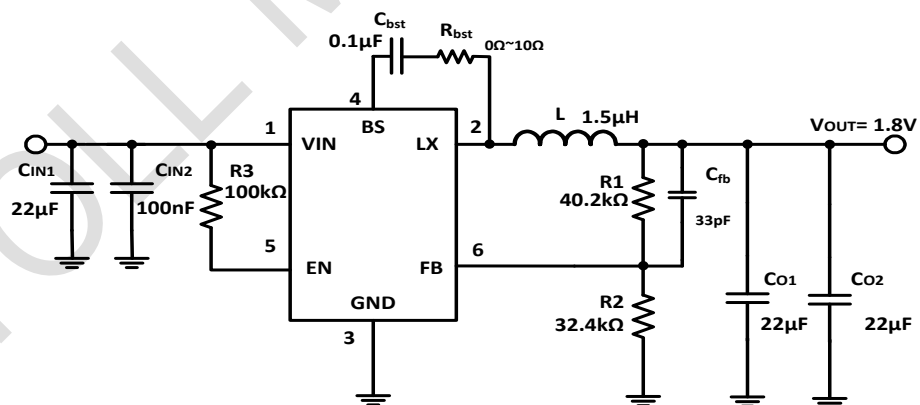
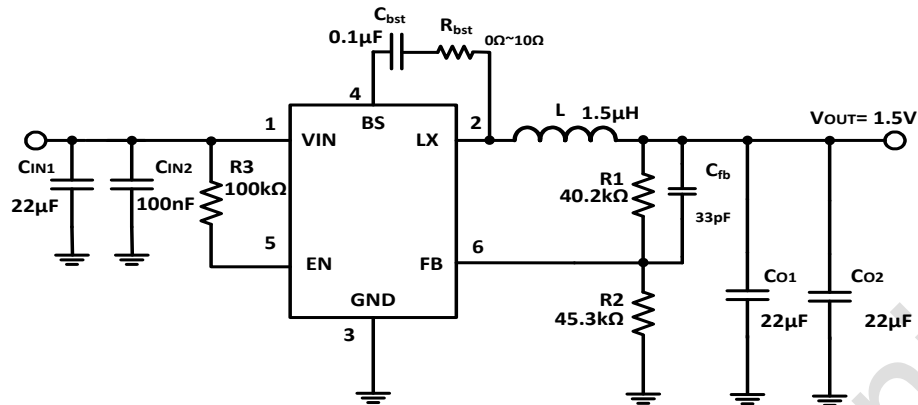
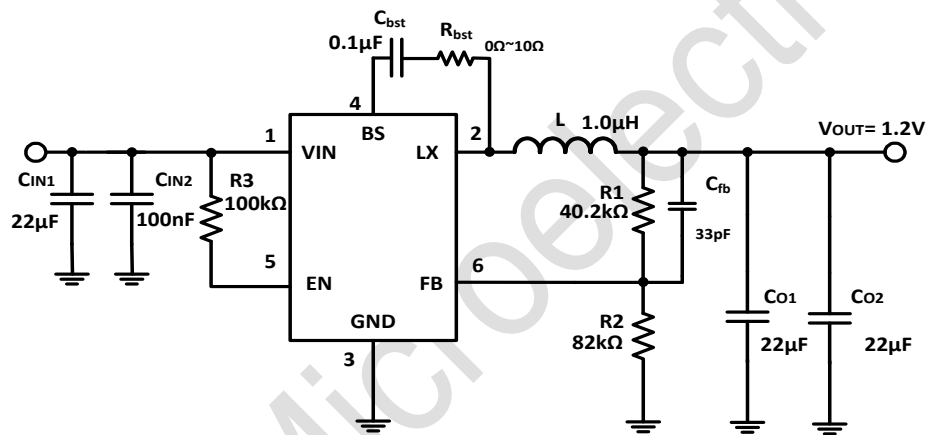
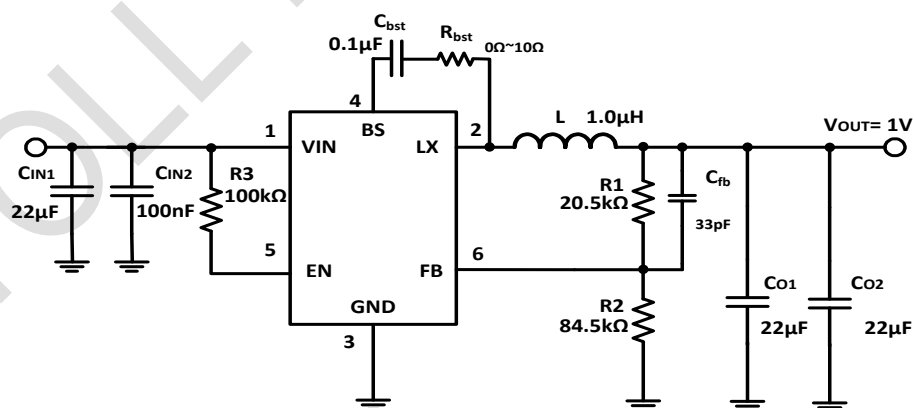


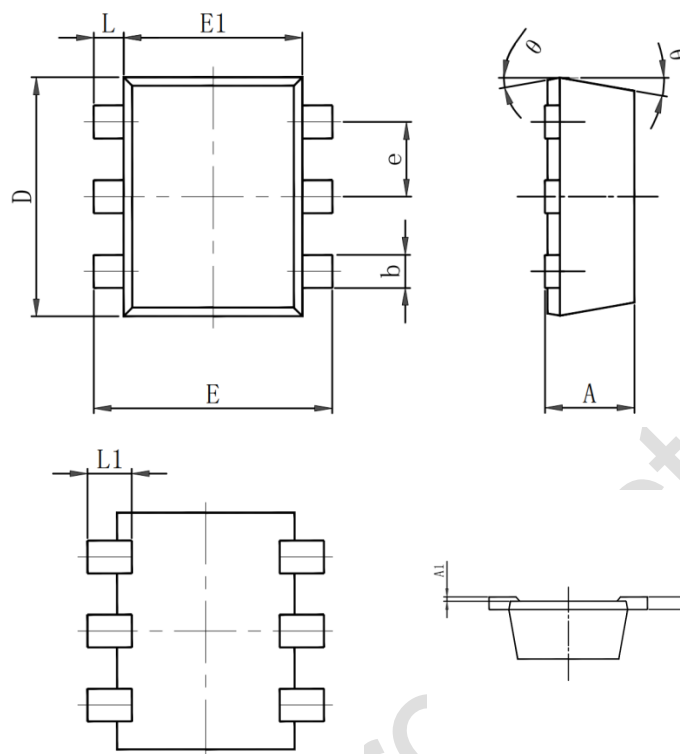
Figure 6. 12V<sub>IN</sub>, 1.8V Output

## TYPICAL APPLICATION CIRCUITS (continued)

Figure 7. 12V<sub>IN</sub>, 1.5V OutputFigure 8. 12V<sub>IN</sub>, 1.2V OutputFigure 9. 12V<sub>IN</sub>, 1V Output

## PACKAGE INFORMATION

### SOT563



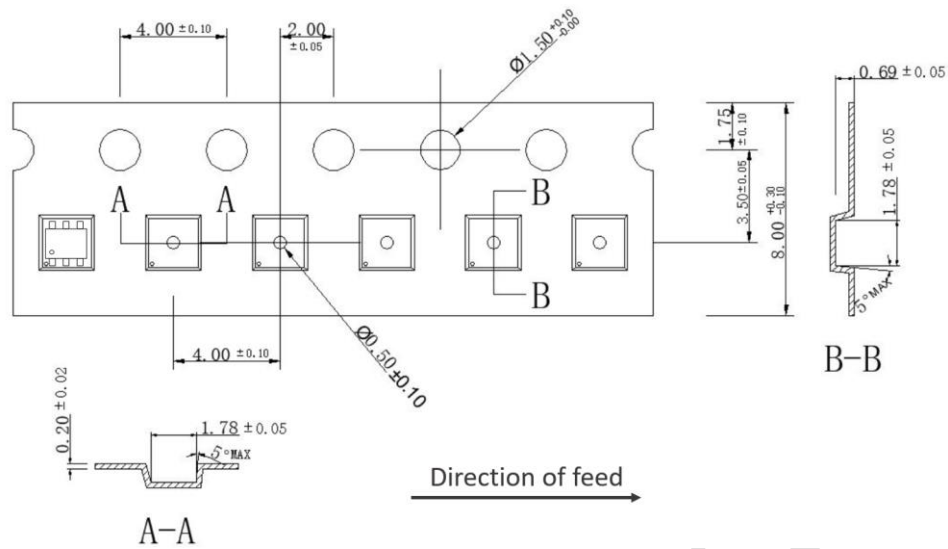
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.525	0.600	0.021	0.024
A1	0.000	0.050	0.000	0.002
e	0.450	0.550	0.018	0.022
c	0.090	0.180	0.004	0.007
D	1.500	1.700	0.059	0.067
b	0.170	0.270	0.007	0.011
E1	1.100	1.300	0.043	0.051
E	1.500	1.700	0.059	0.067
L	0.100	0.300	0.004	0.012
L1	0.200	0.400	0.008	0.016
θ	9° REF.		9° REF.	

**Note:**

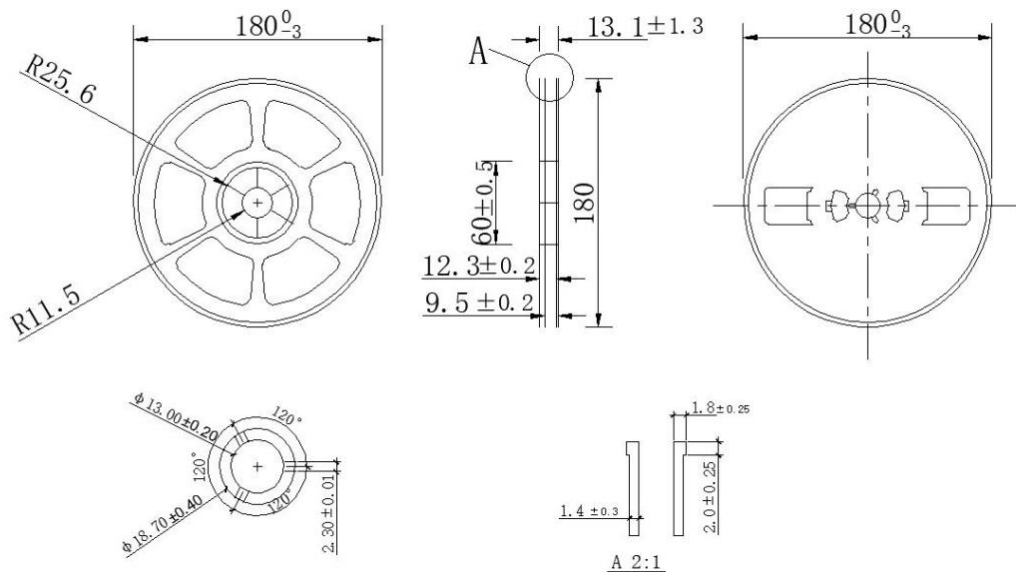
- 1) All dimensions are in millimeters.
- 2) Package length does not include mold flash, protrusion or gate burr.
- 3) Package width does not include interlead flash or protrusion.
- 4) Lead popularity (bottom of leads after forming) shall be 0.10 millimeters max.
- 5) Pin 1 is lower left pin when reading top mark from left to right.

## PACKAGE INFORMATION

### TAPE DIMENSIONS: SOT563



### REEL DIMENSIONS: SOT563



#### Note:

- 1) All Dimensions are in Millimeter
- 2) Quantity of Units per Reel is 5000
- 3) MSL level is level 3.